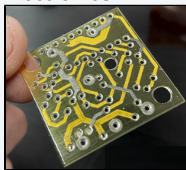
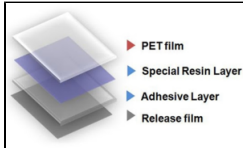


# Multi-layer film forming

| APPLICATIONS                                                                                                           |  | KNOWLEDGE & MODELS                    |                                 | CAPABILITIES                                |                                           |
|------------------------------------------------------------------------------------------------------------------------|--|---------------------------------------|---------------------------------|---------------------------------------------|-------------------------------------------|
| <div>Electronics</div> <div></div>    |  | <div>IC substrate manufacturing</div> |                                 | <div>Core Equipments at ADL Ewha Site</div> |                                           |
| <div>Film formation</div> <div></div> |  |                                       |                                 | <div>Hot Press Machine</div>                |                                           |
|                                                                                                                        |  |                                       |                                 |                                             |                                           |
|                                                                                                                        |  |                                       |                                 |                                             |                                           |
|                                                                                                                        |  | Process                               | Vacuum Hot Press                |                                             |                                           |
|                                                                                                                        |  | Material                              | Polyimide Film                  |                                             |                                           |
|                                                                                                                        |  |                                       | Cu Foil                         |                                             |                                           |
|                                                                                                                        |  |                                       | Prepreg                         |                                             |                                           |
|                                                                                                                        |  | Simulation (VE)                       | bending of FCCL                 |                                             |                                           |
|                                                                                                                        |  |                                       |                                 |                                             |                                           |
| <div>Core Competitiveness at ADL Ewha</div>                                                                            |  | <div>Evaluation Data Library</div>    |                                 | <div>Project History</div>                  |                                           |
| <div>Film Lamination Processing of Microelectronics</div>                                                              |  | Customized Products                   | Liquid Crystal Polymer Products |                                             |                                           |
|                                                                                                                        |  |                                       |                                 | No                                          | Project Title                             |
|                                                                                                                        |  |                                       |                                 | 1                                           | Flexible Copper Clad Laminate development |
|                                                                                                                        |  |                                       |                                 | 2                                           |                                           |
|                                                                                                                        |  |                                       |                                 | 3                                           |                                           |